SCHOTTKY RECTIFIER DIODE



1N5819D2

Variant Options D2A to D2H

- High Surge Capability
- Extremely Fast Switching
- Low Forward Voltage
- Hermetic Ceramic Surface Mount Package Designed as a Drop In Replacement for "D-5A" / "B-MELF" Package[†]
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Space Level and High-Reliability Screening Options Available



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise stated)

V _{RRM}	Repetitive Peak Reverse Voltage	40V
V_{RWM}	Working Peak Reverse Voltage	40V
V_{R}	DC Blocking Voltage	40V
l _F (AV)	Average Forward Current	1.0A
IFSM	Surge Peak Forward Current (Half Sine wave, t _p = 8.3ms)	25A
Tj	Junction Temperature Range	-65 to +125°C
T _{stg}	Storage Temperature Range	-65 to +175°C

THERMAL PROPERTIES

Symbols	Parameters	Max.	Units
R _{0JSP(IN)}	Thermal Resistance, Junction To Solder Pads. T _{SP} = 25°C	62.5	°C/W
R ₀ JA(PCB)	Thermal Resistance, Junction To Ambient (1)	170	°C/W

Notes

(1) PCB = FR4 – 0.0625 Inch (1.59mm), 1 Layer, 1.0-Oz Cu, 0.006 Inch² (1.55mm x 2.67mm²) Pad Size, horizontal, in still air. R_{OJA} is measured at $I_O = 1.0A$, $T_A = 25$ °C.

‡ Recommended solder pad layout dimensions for this device, as detailed within this datasheet for the D-5A device.



Website: http://www.semelab-tt.com



ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise stated)

Symbols	Parameters	Test Conditions	Min.	Тур	Мах.	Units
		I _F = 100mA			360	
$V_F^{(2)}$	Forward Voltage	I _F = 1.0A			600	mV
		I _F = 3A			900	
I _R (2)	Davis and Comment	V _R = 40V			1.0	A
'K	Reverse Current	T _A = 100°C			10	mA

DYNAMIC CHARACTERISTICS

C _T	Junction Capacitance	V _R = 5V	f = 1.0MHz			70	рF	
----------------	----------------------	---------------------	------------	--	--	----	----	--

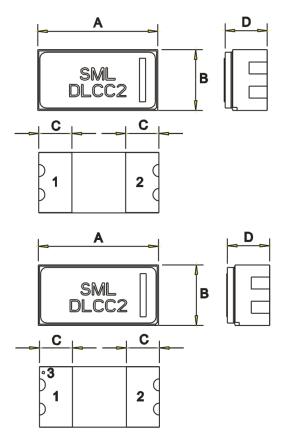
Notes

(2) Pulse Width \leq 380us, $\delta \leq$ 2%

Website: http://www.semelab-tt.com



MECHANICAL DATA



DLCC2 Variants A, C, D, E

Varia	int				
	D2A	Au Plated Terminals			
	D2C	Tape & Reel Option			
	D2D	Hot Solder Dipped Terminals			
	D2F	Hot Solder Dipped Terminals &			
	DZE	Tape & Reel Option			
Pin Out					
	PAD 1	ANODE CATHODE			
	PAD 2				
	DIMENSION	mm	Inches		
	А	5.00 ±0.10	0.197 ±0.004		
	В	2.61 ±0.10	0.103 ±0.004		
	C	1.08 ±0.10	0.043 ±0.004		
	D	1.76 ±0.10	0.069 ±0.004		

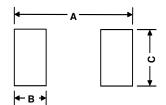
DLCC2 Variants B, F, G, H

Varia		ants b, i , C	,	
	D2B	Au Plated Terminals		
	D2F	Tape & Reel Option		
	D2G	Hot Solder Dipped Terminals		
	D2H	Hot Solder Dipped Terminals & Tape & Reel Option		
Pin O	ut			
	PAD 1	ANODE CATHODE LID CONTACT TO CATHODE*		
	PAD 2			
	PAD 3			
	DIMENSION	mm	Inches	
	А	5.00 ±0.10	0.197 ±0.004	
	В	2.61 ±0.10	0.103 ±0.004	
	C	1.08 ±0.10	0.043 ±0.004	
	D	1.76 ±0.10	0.069 ±0.004	

^{*} The additional contact provides a connection to the lid in the application. Connecting the metal lid to a known electrical potential stops deep dielectric discharge in space applications; see the Space Weather link www.semelab.co.uk/mil/dlcc2 on the Semelab web site. The Package variant & options are to be specified when placing the order.

† The DLCC2 package design takes full advantage of the proven high reliability pedigree of the HTCC surface mount packaging technology, which is easily integrated for automated assembly. Semelab has taken the existing standards for ceramic surface mount package manufacture and added additional design features to enhance thermal performance, to present a competitive alternative for high reliability applications.

SOLDER PAD LAYOUT D-5A

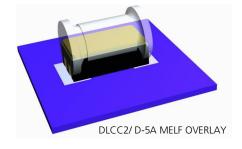


DIMENSION	mm	Inches
А	6.25	0.246
В	1.70	0.067
C	2.67	0.105

Soldering temperature should be 260°C for a maximum of 10 seconds.

PACKAGE MASS

Gold Plated Solder Pad Finish = 83mg



The physical dimensions for the DLCC2 ceramic package are designed to be different from the published dimensions for the "D-5A" and "B-MELF" outlines. The DLCC2 design fully utilises the recommended solder footprint for the "D-5A" / "B-MELF" Package, and as such presents a drop in replacement for existing board designs.

SCHOTTKY RECTIFIER DIODE 1N5819D2



SCREENING OPTIONS

Space Level (JQRS/ESA) and High Reliability options are available in accordance with the High Reliability and Screening Options Handbook available for download from the from the TT electronics Semelab web site.

ESA Quality Level Products are based on the testing procedures specified in the generic ESCC 5000 and in the corresponding part detail specifications.

Semelabs QR216 and QR217 processing specifications (JQRS), in conjunction with the companies ISO 9001:2000 approval present a viable alternative to the American MIL-PRF-19500 space level processing.

QR217 (Space Level Quality Conformance) is based on the quality conformance inspection requirements of MIL-PRF-19500 groups A (table V), B (table VIa), C (table VII) and also ESA / ESCC 5000 (chart F4) lot validation tests.

QR216 (Space Level Screening) is based on the screening requirements of MIL-PRF-19500 (table IV) and also ESA /ESCC 5000 (chart F3).

JQRS parts are processed to the device data sheet and screened to QR216 with conformance testing to Q217 groups A and B in accordance with MIL-STD-750 methods and procedures.

Additional conformance options are available, for example Pre-Cap Visual Inspection, Buy-Off Visit or Data Packs. These are chargeable and must be specified at the order stage (See Ordering Information). Minimum order quantities may apply.

Alternative or additional customer specific conformance or screening requirements would be considered. Contact Semelab sales with enquires.

MARKING DETAILS

Parts can be laser marked with approximately 7 characters on two lines and always includes cathode identification. Typical marking would include part or specification number, week of seal or serial number subject to available space and legibility.

Customer specific marking requirements can be arranged at the time of order.

Example Marking:



ORDERING INFORMATION

Part numbers are built up from Type, Package Variant, and screening level. The part numbers are extended to include the additional options as shown below.

Type – See Electrical Stability Characteristics Table Package Variant – See Mechanical Data Screening Level – See Screening Options (ESA / JQRS)

Additional Options:

Customer Pre-Cap Visual Inspection	.CVP
Customer Buy-Off visit	.CVB
Data Pack	.DA
Solderability Samples	.SS
Scanning Electron Microscopy	.SEM
Radiography (X-ray)	.XRAY
Total Dose Radiation Test	.RAD
MIL-PRF-19500 (QR217)	
Group B charge	.GRPB
Group B destructive mechanical samples	.GBDM (12 pieces)
Group C charge	.GRPC
Group C destructive electrical samples	.GCDE (12 pieces)
Group C destructive mechanical samples	.GCDM (6 pieces)
ESA/ESCC	
Lot Validation Testing (subgroup 1) charge	.LVT1
LVT1 destructive samples (environmental)	.L1DE (15 pieces)
LVT1 destructive samples (mechanical)	.L1DM (15 pieces)
Lot Validation Testing (subgroup 2) charge	.LVT2
LVT2 endurance samples (electrical)	.L2D (15 pieces)
Lot Validation Testing (subgroup 3) charge	.LVT3
LVT3 destructive samples (mechanical)	.L3D (5 pieces)

Additional Option Notes:

- 1) All 'Additional Options' are chargeable and must be specified at order stage.
- 2) When Group B,C or LVT is required, additional electrical and mechanical destructive samples must be ordered
- 3) All destructive samples are marked the same as other production parts unless otherwise requested.

Example ordering information:

The following example is for the 1N5819 part with package variant A, JQRS screening, additional Group C conformance testing and a Data pack.

Part Numbers:

1N5819D2A-JQRS (Include quantity for flight parts) 1N5819D2A-JQRS.GRPC (chargeable conformance option) 1N5819D2A-JQRS.GCDE (charge for destructive parts) 1N5819D2A-JQRS.GCDM (charge for destructive parts) 1N5819D2A-JQRS.DA (charge for Data pack)

Customers with any specific requirements (e.g. marking or screening) may be supplied with a similar alternative part number (there is maximum 20 character limit to part numbers). Contact Semelab sales with enquiries

High Reliability and Screening Options Handbook link: http://www.semelab.co.uk/pdf/misc/documents/hirel_and_screening_options.pdf